



BOARD CHARACTERISTICS

Copper Layer Count:	4	Board Thickness:	0.062 in
Board overall dimensions:	70.5000 mm x 133.9000 mm		
Min track/spacing:	0.0762 mm / 0.0762 mm	Min hole diameter:	0.0762 mm
Copper Finish:	ENIG	Impedance Control:	No
Castellated pads:	No	Plated Board Edge:	No
Edge card connectors:	No		